

MOSFET

OptiMOS™ Power-Transistor, 60 V

Features

- Optimized for high performance SMPS, e.g. sync. rec.
- 100% avalanche tested
- Superior thermal resistance
- N-channel
- Pb-free lead plating; RoHS compliant
- Halogen-free according to IEC61249-2-21
- Higher solder joint reliability due to enlarged source interconnection

Product validation

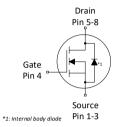
Fully qualified according to JEDEC for Industrial Applications

Table 1 **Key Performance Parameters**

Parameter	Value	Unit
$V_{ m DS}$	60	V
$R_{\mathrm{DS(on),max}}$	1.45	mΩ
I_{D}	257	А
Q _{oss}	100	nC
Q _G (0V10V)	89	nC











Type/Ordering Code	Package	Marking	Related Links
BSC014N06NS	PG-TDSON-8	014N06NS	-

Public

OptiMOS™ Power-Transistor, 60 V BSC014N06NS



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1 Maximum ratings

unless otherwise specified

Table 2 Maximum ratings

Parameter	Symbol	Values			Unit	Nieto/Test Condition
raiailietei	Syllibot	Min.	Тур.	Max.	Offic	Note/ Test Condition
Continuous drain current ¹⁾	I_{D}	-	-	257 182 31	А	$V_{\rm GS}$ =10 V, $T_{\rm C}$ =25 °C $V_{\rm GS}$ =10 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =10 V, $T_{\rm A}$ =25 °C, $R_{\rm thJA}$ =50K/W ²⁾
Pulsed drain current ³⁾	I _{D,pulse}	-	-	1028	А	<i>T</i> _C =25 °C
Avalanche energy, single pulse ⁴⁾	E _{AS}	-	-	580	mJ	$I_{\rm D}$ =50 A, $R_{\rm GS}$ =25 Ω
Gate source voltage	V_{GS}	-20	-	20	V	-
wer dissipation P_{tot} - $\begin{bmatrix} 188 \\ 3.0 \end{bmatrix}$ W		W	$T_{\rm C}$ =25 °C $T_{\rm A}$ =25 °C, $R_{\rm thJA}$ =50 K/W ²⁾			
Operating and storage temperature	$T_{\rm j},T_{\rm stg}$	-55	-55 - 175		°C	-

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions

Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm 2 (one layer, 70 μ m thick) copper area for drain connection. PCB is vertical in still air.

³⁾ See Diagram 3 for more detailed information

⁴⁾ See Diagram 13 for more detailed information



2 Thermal characteristics

Table 3 Thermal characteristics

Parameter	Symbol	Values			l lmit	Note / Test Condition
Parameter	Symbol	Min.	Тур.	Мах.	Unit	Note/ Test Condition
Thermal resistance, junction - case	R_{thJC}	-	0.5	0.8	K/W	-
Thermal resistance, junction - case, top	R_{thJC}	-	-	20	K/W	-
Device on PCB, 6 cm ² cooling area ⁵⁾	R_{thJA}	-	-	50	K/W	-

Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm 2 (one layer, 70 μ m thick) copper area for drain connection. PCB is vertical in still air.



3 Electrical characteristics

unless otherwise specified

Table 4 Static characteristics

Parameter	Symbol		Values			Nato/Tast Candition
Parameter	Syllibol	Min.	Тур.	Мах.	Unit	Note/ Test Condition
Drain-source breakdown voltage	$V_{(BR)DSS}$	60	-	-	V	$V_{\rm GS}$ =0 V, $I_{\rm D}$ =1 mA
Gate threshold voltage	$V_{\rm GS(th)}$	2.1	2.8	3.3	V	$V_{\rm DS} = V_{\rm GS}, I_{\rm D} = 120 \mu{\rm A}$
Zero gate voltage drain current	gate voltage drain current I_{DSS} - $\begin{bmatrix} 0.5 & 1 \\ 10 & 100 \end{bmatrix} \mu A$		μΑ	$V_{\rm DS}$ =60 V, $V_{\rm GS}$ =0 V, $T_{\rm j}$ =25 °C $V_{\rm DS}$ =60 V, $V_{\rm GS}$ =0 V, $T_{\rm j}$ =125 °C		
Gate-source leakage current	I_{GSS}	-	10	100	nA	V _{GS} =20 V, V _{DS} =0 V
Drain-source on-state resistance	$R_{\mathrm{DS(on)}}$	-	1.2 1.6	1.45 2.2	mΩ	$V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A $V_{\rm GS}$ =6 V, $I_{\rm D}$ =12.5 A
Gate resistance ⁶⁾	R_{G}	-	2 3		Ω	-
Transconductance	g_{fs}	75	150	-	S	$ V_{\rm DS} > 2 I_{\rm D} R_{\rm DS(on)max}, I_{\rm D} = 50 \text{ A}$

⁶⁾ Defined by design. Not subject to production test

Table 5 Dynamic characteristics 7)

Darameter	Symbol	Values			Unit	Nieto/Tost Condition
Parameter		Min.	Тур.	Max.		Note/ Test Condition
Input capacitance	C _{iss}	-	6500	8125	pF	V _{GS} =0 V, V _{DS} =30 V, <i>f</i> =1 MHz
Output capacitance	C _{oss}	-	1500	1875	pF	V _{GS} =0 V, V _{DS} =30 V, <i>f</i> =1 MHz
Reverse transfer capacitance	C _{rss}	-	59	118	pF	$V_{\rm GS}$ =0 V, $V_{\rm DS}$ =30 V, f =1 MHz
Turn-on delay time	$t_{\sf d(on)}$	_	23	-	ns	$V_{\rm DD}$ =30 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =30 A, $R_{\rm G,ext}$ =2 Ω
Rise time	t _r	-	10	-	ns	$V_{\rm DD}$ =30 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =30 A, $R_{\rm G,ext}$ =2 Ω
Turn-off delay time	$t_{\sf d(off)}$	-	43	-	ns	$V_{\rm DD}$ =30 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =30 A, $R_{\rm G,ext}$ =2 Ω
Fall time	t_{f}	_	11	-	ns	$V_{\rm DD}$ =30 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =30 A, $R_{\rm G,ext}$ =2 Ω

⁷⁾ Defined by design. Not subject to production test

Table 6 Gate charge characteristics 8)

Parameter	Symbol	Values			Unit	Note/ Test Condition
	Symbol	Min.	Тур.	Мах.	Unit	Note/ Test Condition
Gate to source charge	$Q_{ m gs}$	-	28	-	nC	$V_{\rm DD}$ =30 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 10 V
Gate charge at threshold	$Q_{\mathrm{g(th)}}$	-	18	-	nC	$V_{\rm DD}$ =30 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 10 V
Gate to drain charge	$Q_{ m gd}$	-	16	21	nC	$V_{\rm DD}$ =30 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 10 V



Table 6 Gate charge characteristics 8)

Parameter	Symbol	Values			Unit	Note / Test Condition
	Symbol	Min.	Тур.	Мах.	Oilit	Note/ Test Condition
Switching charge	Q_{sw}	-	26	-	nC	$V_{\rm DD}$ =30 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 10 V
Gate charge total	$Q_{ m g}$	-	89	104	nC	$V_{\rm DD}$ =30 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 10 V
Gate plateau voltage	$V_{ m plateau}$	-	4.3	-	V	$V_{\rm DD}$ =30 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 10 V
Gate charge total, sync. FET	$Q_{\rm g(sync)}$	-	78	-	nC	$V_{\rm DS}$ =0.1 V, $V_{\rm GS}$ =0 to 10 V
Output charge	Q _{oss}	-	100	125	nC	V _{DD} =30 V, V _{GS} =0 V

⁸⁾ See "Gate charge waveforms" for parameter definition. Defined by design. Not subject to production test

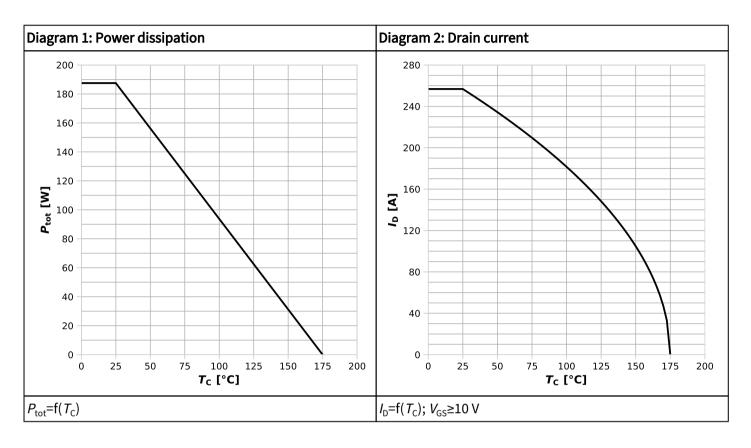
Table 7 Reverse diode

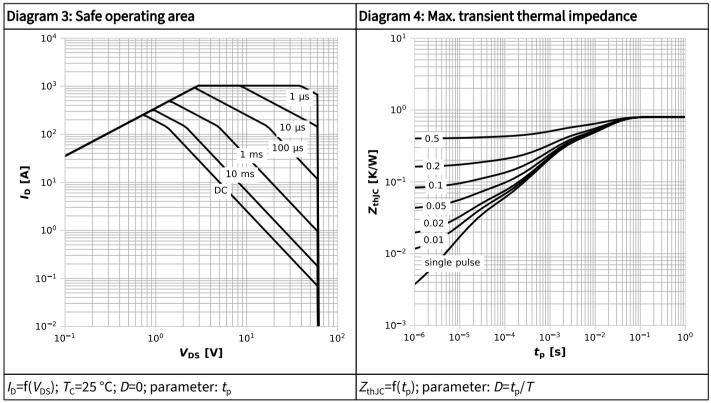
Parameter	Symbol	Values			Unit	Note / Test Condition
raiametei	Symbol	Min.	Тур.	Мах.	Unit	Note/ Test Condition
Diode continuous forward current	Is	-	-	156	А	<i>T</i> _c =25 °C
Diode pulse current	I _{S,pulse}	-	-	1028	А	<i>T</i> _C =25 °C
Diode forward voltage	$V_{\rm SD}$	-	0.84	1.2	V	$V_{\rm GS}$ =0 V, $I_{\rm F}$ =50 A, $T_{\rm j}$ =25 °C
Reverse recovery time ⁹⁾	t _{rr}	-	52	83	ns	$V_{\rm R}$ =30 V, $I_{\rm F}$ =50 A, d $i_{\rm F}$ /d t =100 A/ μ s
Reverse recovery charge ⁹⁾	$Q_{\rm rr}$	-	139	-	nC	$V_{\rm R}$ =30 V, $I_{\rm F}$ =50 A, d $i_{\rm F}$ /d t =100 A/ μ s

 $^{^{9)}}$ Defined by design. Not subject to production test

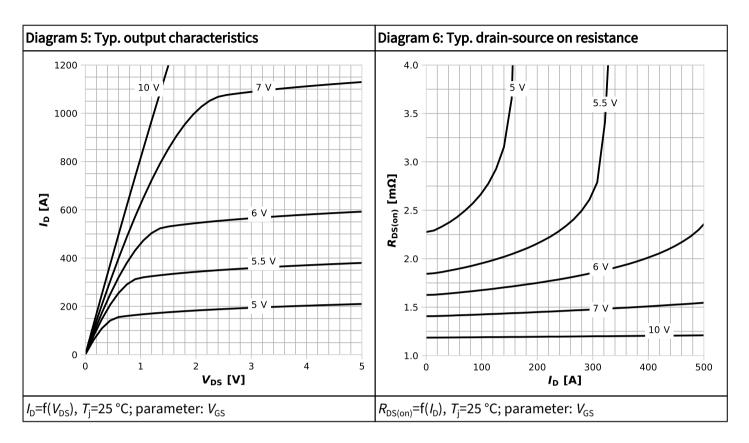


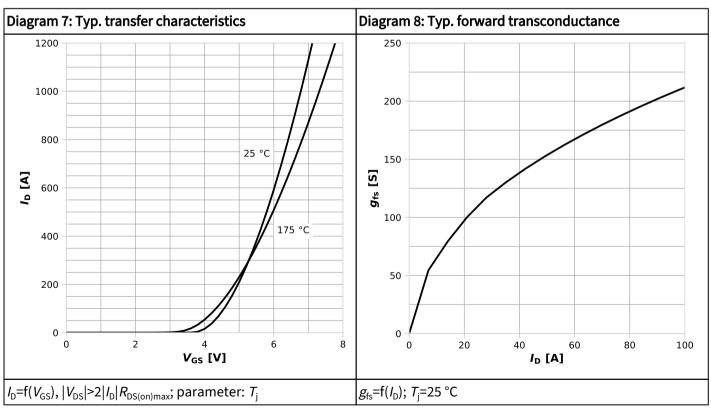
4 Electrical characteristics diagrams



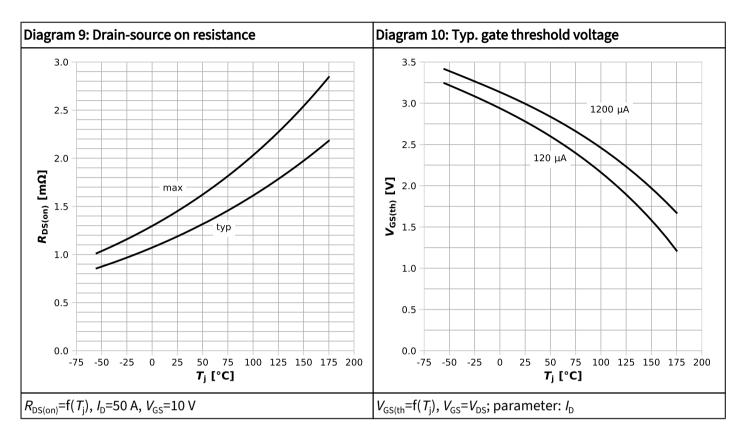


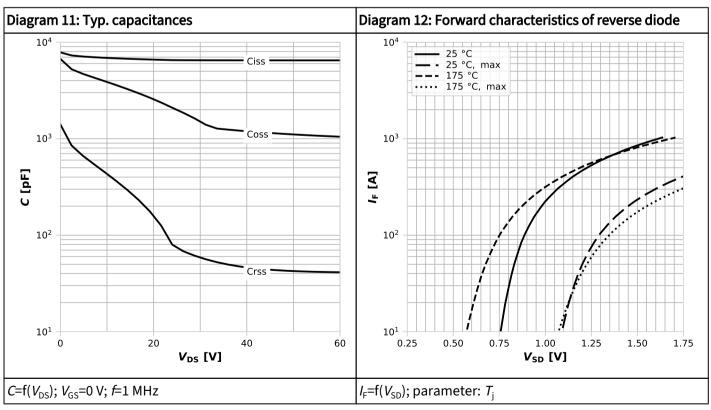




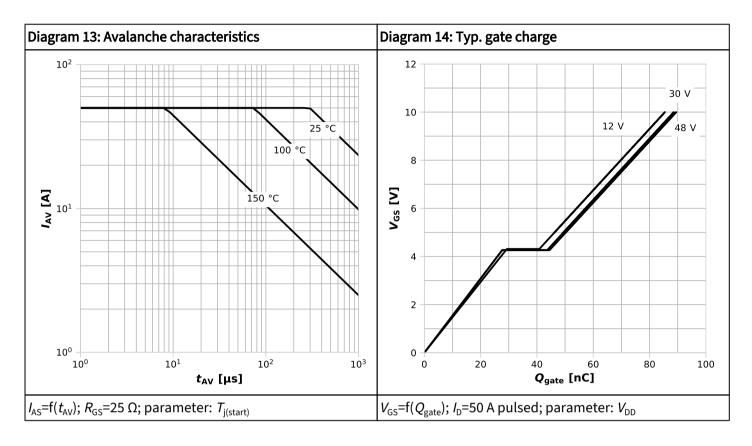


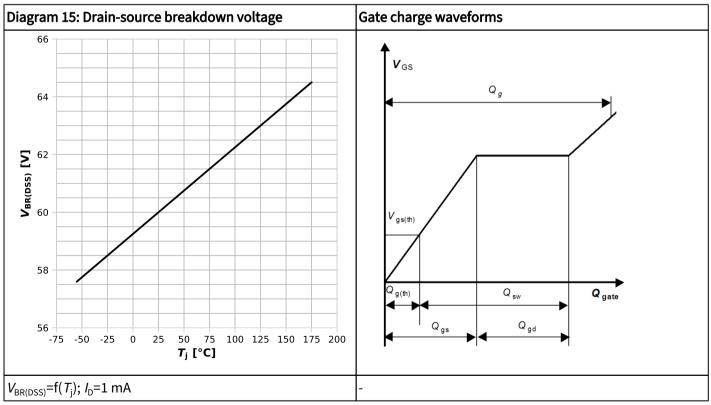














5 Package Outlines

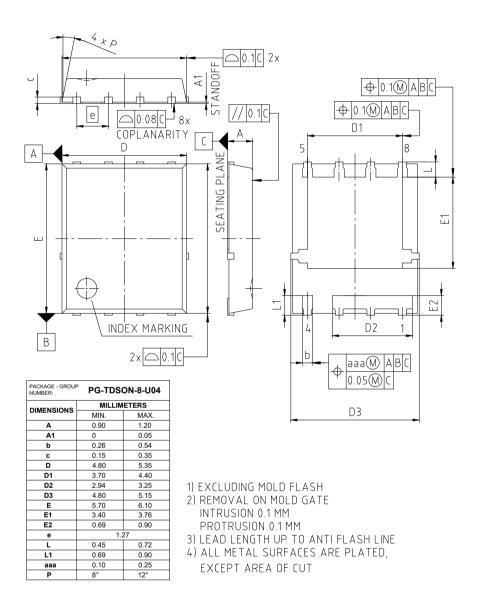


Figure 1 Outline PG-TDSON-8, dimensions in mm



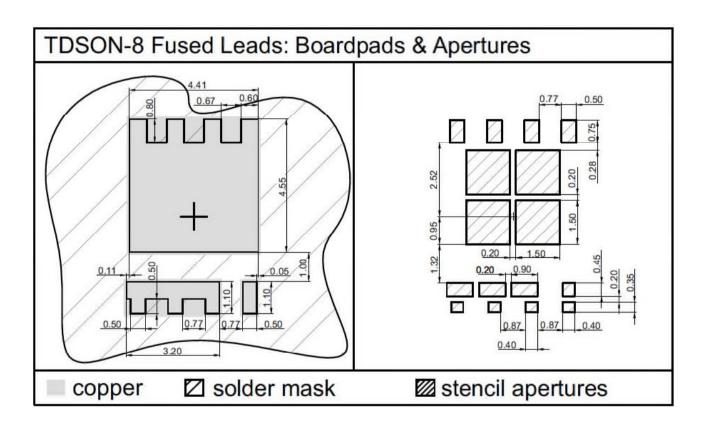


Figure 2 Outline PG-TDSON-8, dimensions in mm



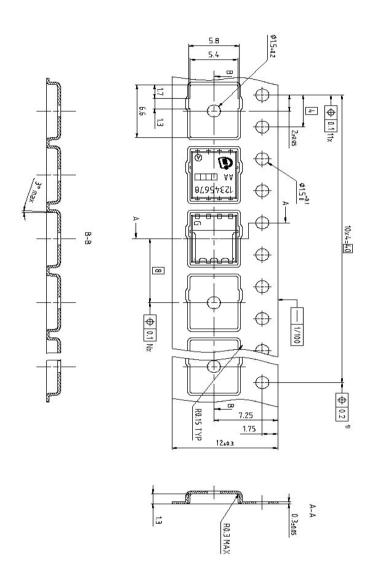


Figure 3 Outline PG-TDSON-8, dimensions in mm



Revision History

BSC014N06NS

Revision 2024-06-11, Rev. 2.6

Previous Revision

Revision	Date	Subjects (major changes since last revision)
2.3	2014-10-16	Rev.2.3
2.4	2020-02-28	Update current rating
2.5	2022-08-09	Update outline drawing and footnotes
2.6	2024-06-11	Upgrade Operating and storage temperature max to 175°C. Update drawings in section 5 Package Outlines. Production validation added on page1. Updated foot notes.

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